Product data sheet

1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 5 A
- Reverse voltage: V_R ≤ 30 V
- · Low forward voltage
- · High power capability due to clip-bond technology
- Small and flat lead SMD plastic package
- · Suitable for both reflow and wave soldering
- · Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- · Reverse polarity protection
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \le$ 135 °C	-	-	5	Α
V _R	reverse voltage	T _j = 25 °C	-	-	30	V
V _F	forward voltage	I _F = 5 A; T _j = 25 °C	-	400	450	mV
I _R	reverse current	$V_R = 30 \text{ V}; T_j = 25 \text{ °C}$	-	90	250	μΑ

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		K .JK. A
2	A	anode	1	sym001

[1] The marking bar indicates the cathode.



6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PMEG3050BEP-Q	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128		

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG3050BEP-Q	A8

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	30	V
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 20 °C	[1]	-	5	A
		$δ$ = 0.5; f = 20 kHz; square wave; T_{sp} ≤ 135 °C		-	5	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half-sine wave; $T_{j(init)}$ = 25 °C		-	70	A
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	625	mW
			[3]	-	1.05	W
			[1]	-	2.1	W
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- Device mounted on a ceramic PCB, Al_2O_3 , standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint. Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-a)} thermal resistance from junction to ambient	thermal resistance from	1	[1] [2]	-	-	200	K/W
	junction to ambient		[3] [2]	-	-	120	K/W
			[4] [2]	-	-	60	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

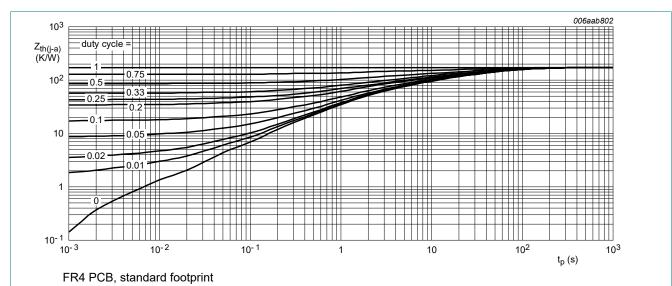


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

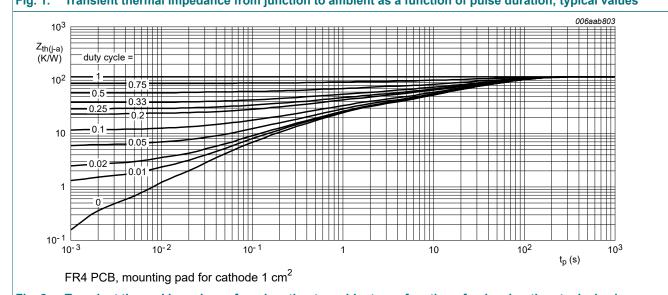
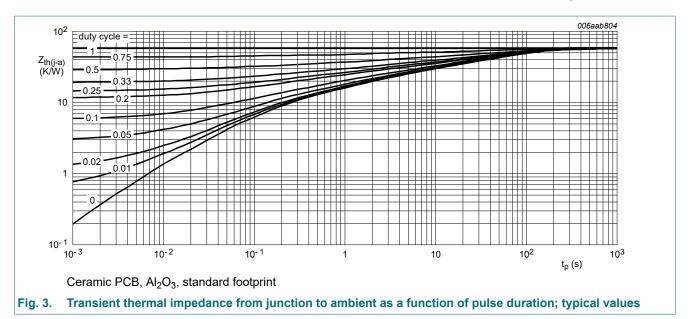


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

3 / 12



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C	-	270	300	mV
		I _F = 0.5 A; T _j = 25 °C	-	315	360	mV
		I _F = 1 A; T _j = 25 °C	-	335	380	mV
		I _F = 2 A; T _j = 25 °C	-	360	420	mV
		I _F = 3 A; T _j = 25 °C	-	380	440	mV
		I _F = 5 A; T _j = 25 °C	-	400	450	mV
I _R reverse current	reverse current	V _R = 5 V; T _j = 25 °C	-	10	-	μΑ
		V _R = 10 V; T _j = 25 °C	-	15	-	μΑ
		V _R = 30 V; T _j = 25 °C	-	90	250	μΑ
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	800	-	pF
		V _R = 10 V; f = 1 MHz; T _i = 25 °C	-	275	-	pF

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V_R(V)

30 V, 5 A low VF Schottky barrier rectifier

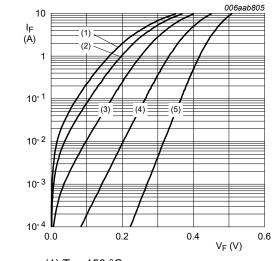
(1)

(2)

(3)

(4)

20



(1) $T_i = 150 \, ^{\circ}C$

 $(2) T_i = 125 °C$

(3) $T_i = 85 °C$

 $(4) T_i = 25 ^{\circ}C$

(5) $T_i = -40$ °C

Fig. 4. Forward current as a function of forward voltage; typical values



10⁻¹ I_R (A) 10⁻²

10⁻³

10-4

10^{- 5}

10⁻⁶

10⁻⁷

10⁻⁸

Fig. 5. Reverse current as a function of reverse voltage; typical values

10

(1) $T_i = 125 \,^{\circ}C$

 $(2) T_i = 85 °C$

 $(3) T_i = 25 ^{\circ}C$

(4) $T_j = -40 \, ^{\circ}C$

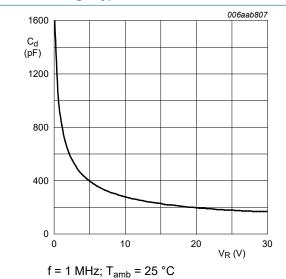
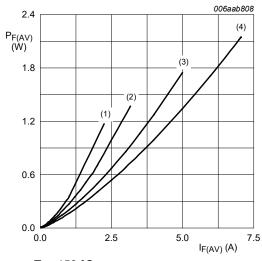


Fig. 6. Diode capacitance as a function of reverse voltage; typical values



T_i = 150 °C

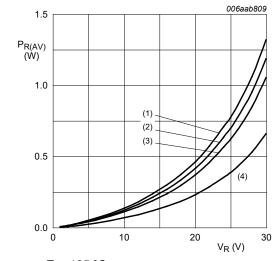
 $(1) \delta = 0.1$

 $(2) \delta = 0.2$

 $(3) \delta = 0.5$ $(4) \delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values

5/12



T_i = 125 °C

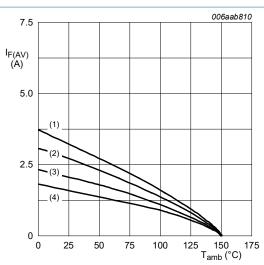
 $(1) \delta = 1$

 $(2) \delta = 0.9$

 $(3) \delta = 0.8$

 $(4) \delta = 0.5$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T_i = 150 °C

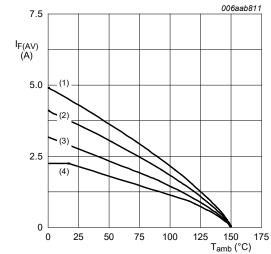
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

T_i = 150 °C

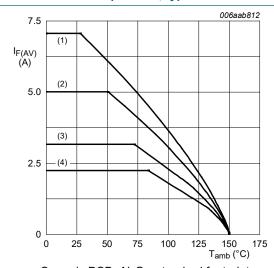
 $(1) \delta = 1$; DC

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

 $T_i = 150 \,{}^{\circ}\text{C}$

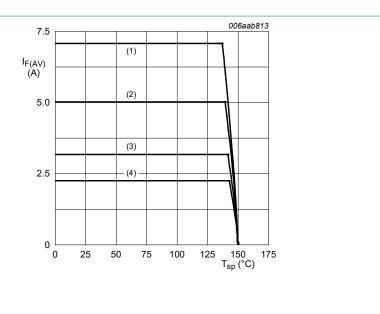
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



 $T_j = 150 \,^{\circ}\text{C}$

 $(1) \delta = 1; DC$

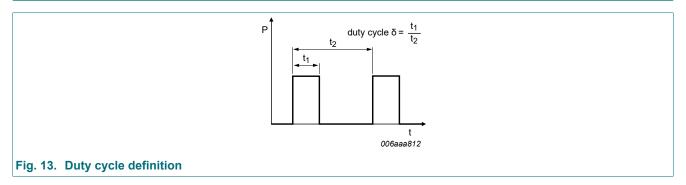
(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

 $(4) \delta = 0.1$; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

11. Test information



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current

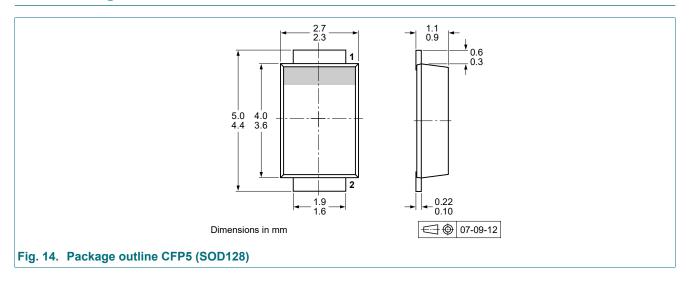
 $I_{RMS}=I_{F(AV)}$ at DC

 $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current

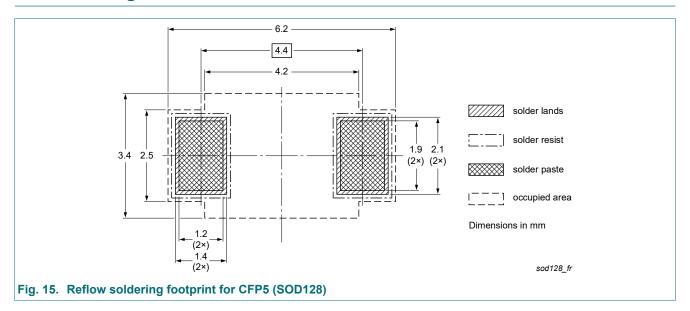
Quality information

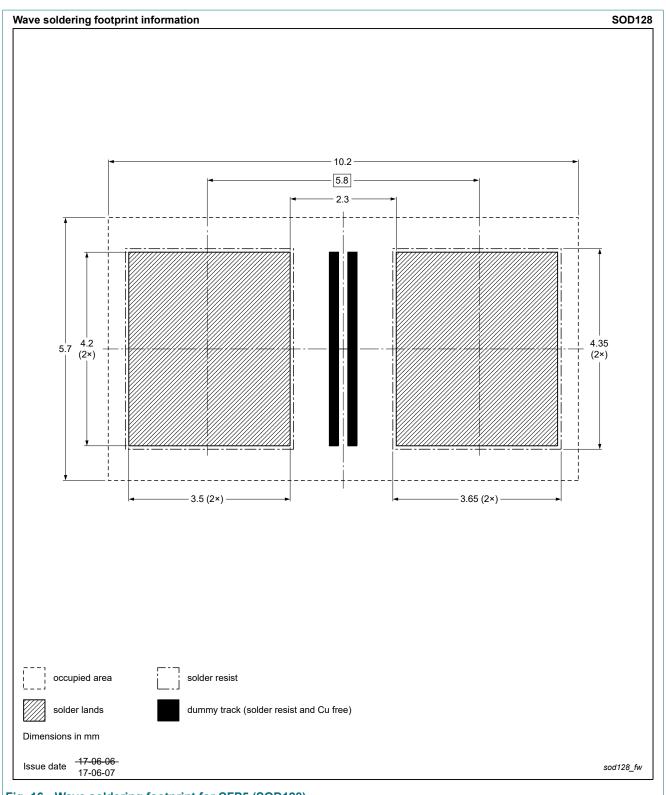
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG3050BEP-Q v.2	20230220	Product data sheet	-	PMEG3050BEP-Q v.1				
Modifications:		 Limiting values: Measurement conditions for I_{FSM} changed from square wave to half-sine wave. 						
PMEG3050BEP-Q v.1	20210608	Product data sheet	-	-				

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	1
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	2
	Thermal characteristics	
10	. Characteristics	4
11.	. Test information	7
12	. Package outline	8
	. Soldering	
	. Revision history	
	. Legal information	
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